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FDB8441

N-Channel PowerTrench® MOSFET 40V, 120A, 2.5m Ω

Features

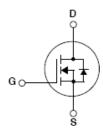
- Typ $r_{DS(on)}$ = 1.9m Ω at V_{GS} = 10V, I_D = 80A
- Typ $Q_{g(10)}$ = 215nC at V_{GS} = 10V
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- RoHS Compliant

Applications

- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter / Alternator
- Distributed Power Architectures and VRMs
- Primary Switch for 12V Systems







MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V_{DS}	Drain to Source Voltage		40	V
V_{GS}	Gate to Source Voltage		±20	V
	Drain Current Continuous (T _C = 25°C, Silicon limited)		262*	
	Drain Current Continuous (T _C = 100°C, Silicon limited)		185*	
I _D	Drain Current Continuous (T _C = 25°C, Package limited)		120	Α
	Drain Current Continuous (T _A = 25°C, R _{θJA} = 43°C/W)		28	
	Pulsed		See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (N	ote 1)	947	mJ
D	Power dissipation		300	W
r _D	Derate above 25°C		2	W/°C
T _J , T _{STG}	Operating and Storage Temperature		-55 to 175	°C

^{*}Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case		0.5	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient (Note 2)		62	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient, 1in ² copper pad area		43	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8441	FDB8441	TO-263AB	330mm	24mm	800 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units

Off Characteristics

B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS}$	= 0V	40	-	-	V
I _{DSS} Zero Gate Voltage Drain Current	V _{DS} = 32V		-	-	1	^	
	Zero Gate Voltage Drain Current	$V_{GS} = 0V$	T _J = 150°C	-	-	250	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	1	±100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	2.8	4	V
		$I_D = 80A, V_{GS} = 10V$	-	1.9	2.5	
r _{DS(on)}	Drain to Source On Resistance	$I_D = 80A, V_{GS} = 10V,$ $T_J = 175^{\circ}C$	-	3.3	4.3	mΩ

Dynamic Characteristics

C _{iss}	Input Capacitance	V 05V V 0V		-	15000	-	pF
C _{oss}	Output Capacitance	$V_{DS} = 25V, V_{GS}$ = f = 1MHz	$V_{DS} = 25V, V_{GS} = 0V,$		1250	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11VII 12	1 - 1101112		685	-	pF
R_G	Gate Resistance	V _{GS} = 0.5V, f = 1	$V_{GS} = 0.5V$, $f = 1MHz$		1.1	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	V _{GS} = 0 to 10V		-	215	280	nC
$Q_{g(TH)}$	Threshold Gate Charge	V _{GS} = 0 to 2V	V _{DD} = 20V	-	29	38	nC
Q _{gs}	Gate to Source Gate Charge		I _D = 35A	-	60	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		$I_g = 1mA$		32	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	49	-	nC

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Symbol Parameter lest Conditions Min Typ Max Units	Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
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Switching Characteristics

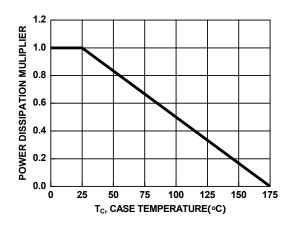
t _(on)	Turn-On Time		-	-	77	ns
t _{d(on)}	Turn-On Delay Time		-	23	-	ns
t _r	Turn-On Rise Time	V_{DD} = 20V, I_{D} = 35A V_{GS} = 10V, R_{GS} = 1.5 Ω		24	-	ns
t _{d(off)}	Turn-Off Delay Time			75	-	ns
t _f	Turn-Off Fall Time			17.9	-	ns
t _{off}	Turn-Off Time		-	-	147	ns

Drain-Source Diode Characteristics

V _{SD} Source	Source to Drain Diode Voltage	I _{SD} = 35A	-	0.8	1.25	V
	Source to Drain blode voltage	I _{SD} = 15A	-	0.8	1.0	V
t _{rr}	Reverse Recovery Time	I _F = 35A, di/dt = 100A/μs	-	52	68	ns
Q _{rr}	Reverse Recovery Charge	I _F = 35A, di/dt = 100A/μs	-	76	99	nC

Notes: 1: Starting $T_J = 25^{\circ}C$, L = 0.46mH, $I_{AS} = 64A$. 2: Pulse width = 100s.

Typical Characteristics



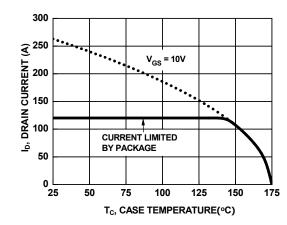


Figure 1. Normalized Power Dissipation vs Case Temperature

Figure 2. Maximum Continuous Drain Current vs Case Temperature

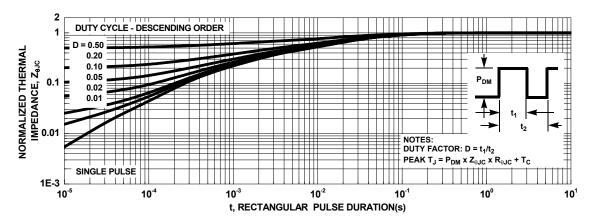


Figure 3. Normalized Maximum Transient Thermal Impedance

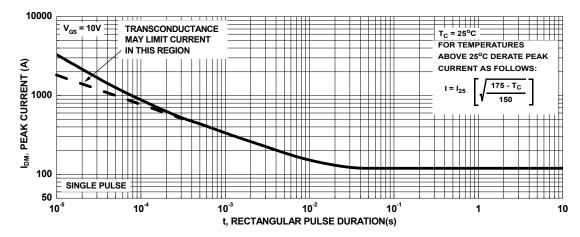


Figure 4. Peak Current Capability

Typical Characteristics

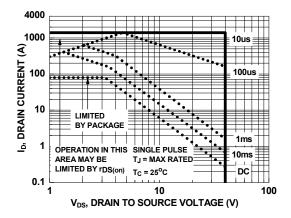
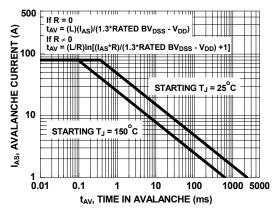


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

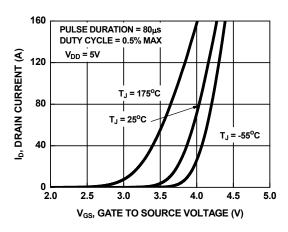


Figure 7. Transfer Characteristics

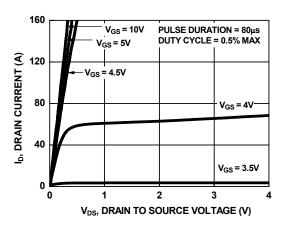


Figure 8. Saturation Characteristics

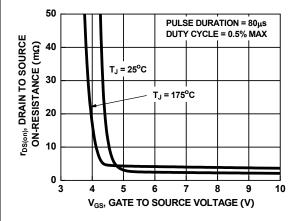


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

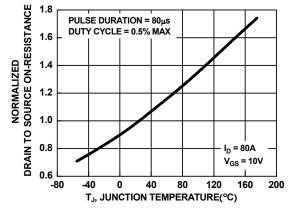


Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics

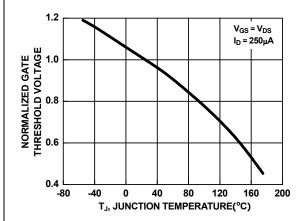


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

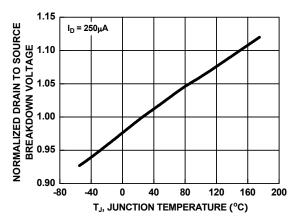


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

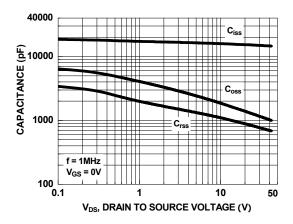


Figure 13. Capacitance vs Drain to Source Voltage

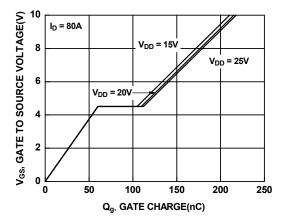


Figure 14. Gate Charge vs Gate to Source Voltage





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